



Activities in Wuhan

TopMetal sensor & ALICE ITS upgrade

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CCNU

ALICE ITS Upgrade and O2 Asian Workshop 2014

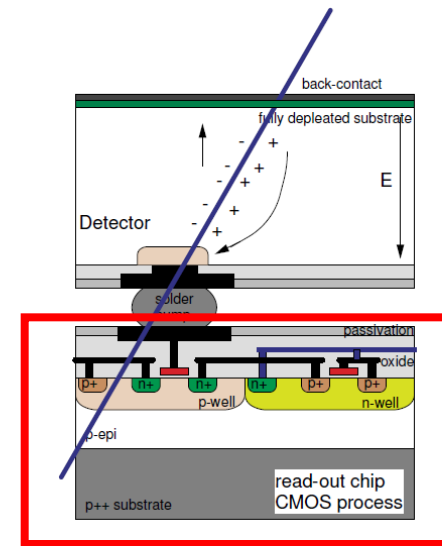


outline

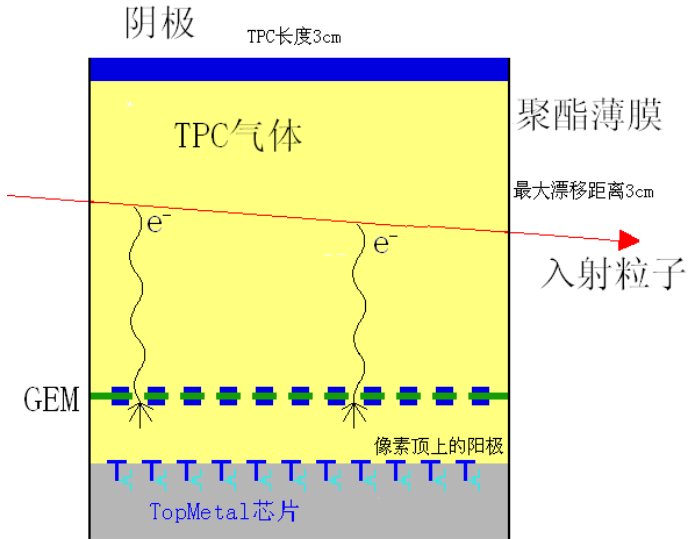
- TopMetal sensor design test & application
- ALICE ITS sensor : temperature sensor
- ALICE ITS test and assembly : infrastructure & pattern recognition
- ALICE ITS readout : SRU & UDP+TCP
- summary

silicon isn't the ideal detector material

the readout chip of hybrid detector can be used like a independent detector



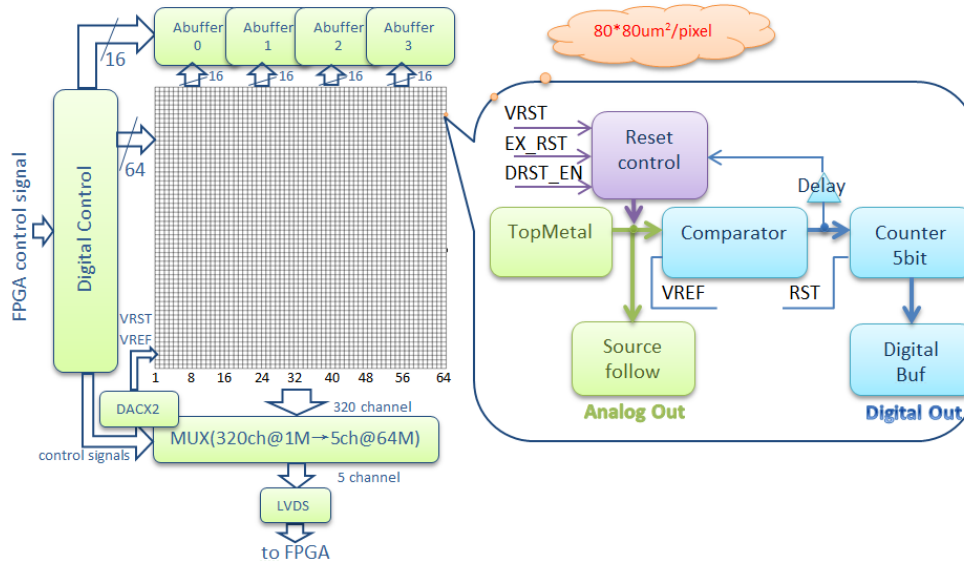
TopMetal sensor



the top layer metal opens to the air, collecting charge drifted to it

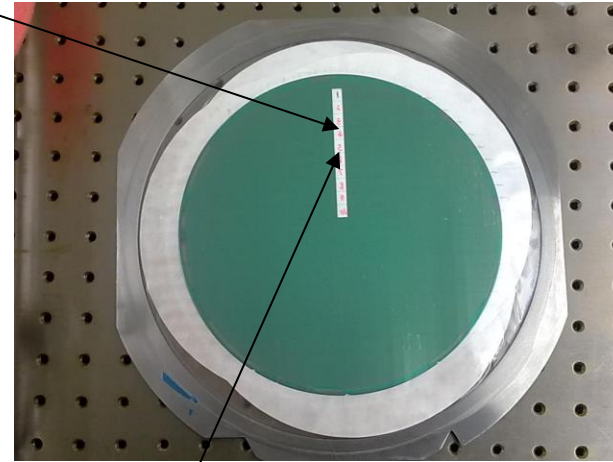
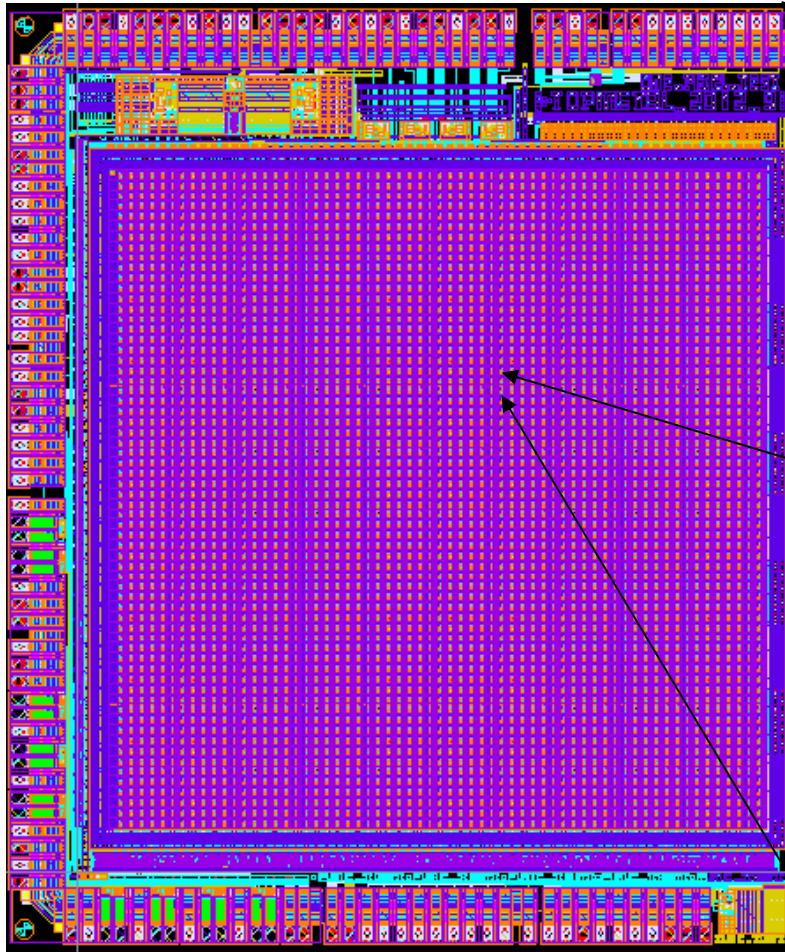
advantage:

direct collecting charge coupled with other type of detectors

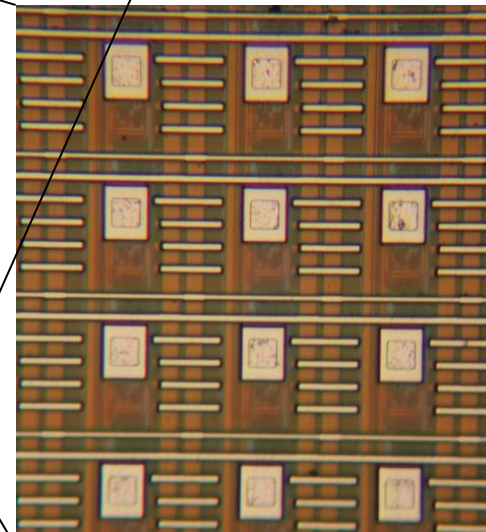


TopMetal structure

TopMetal wafer

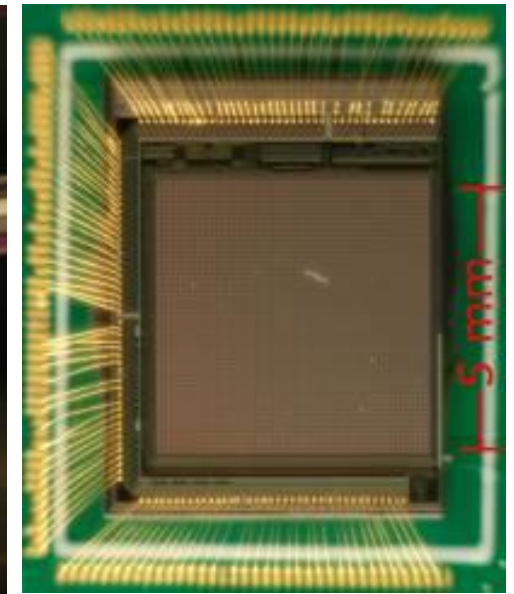
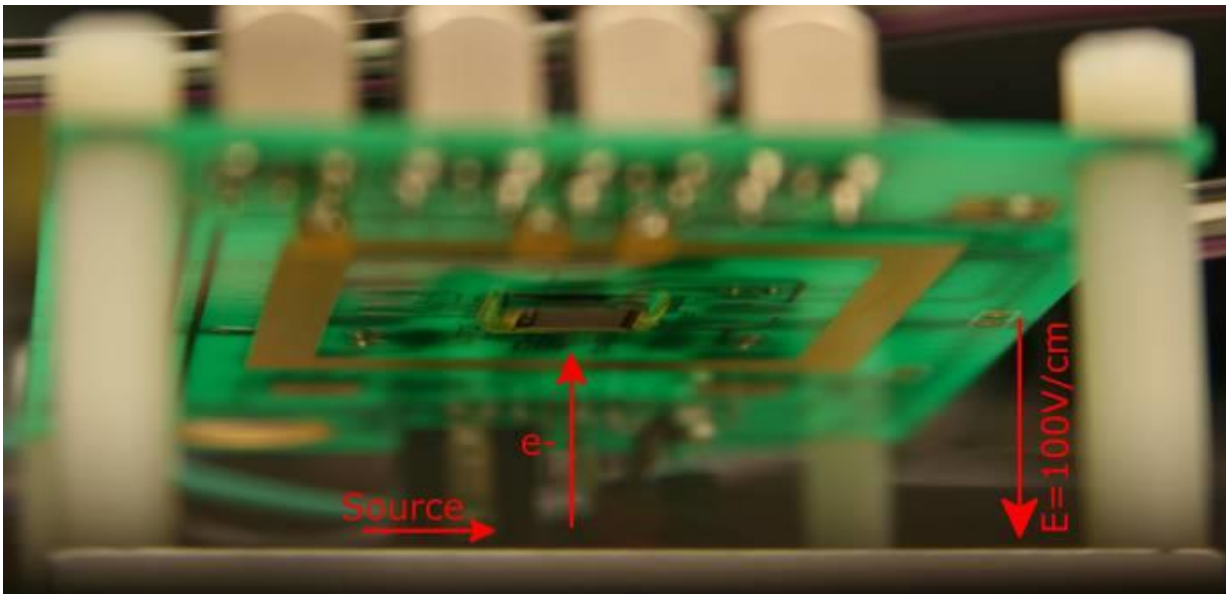
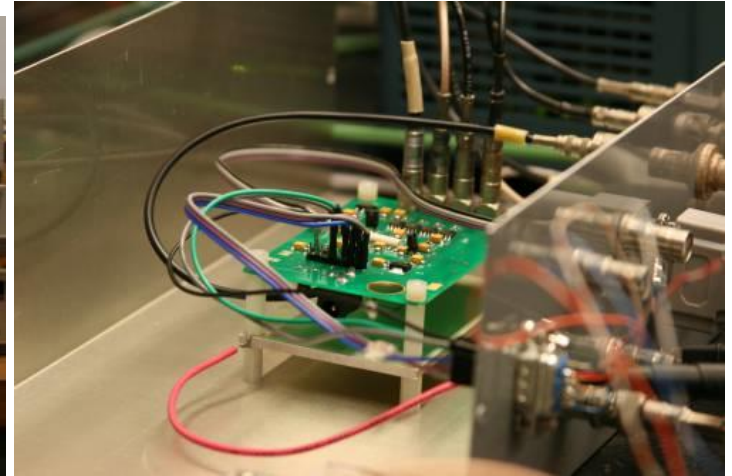
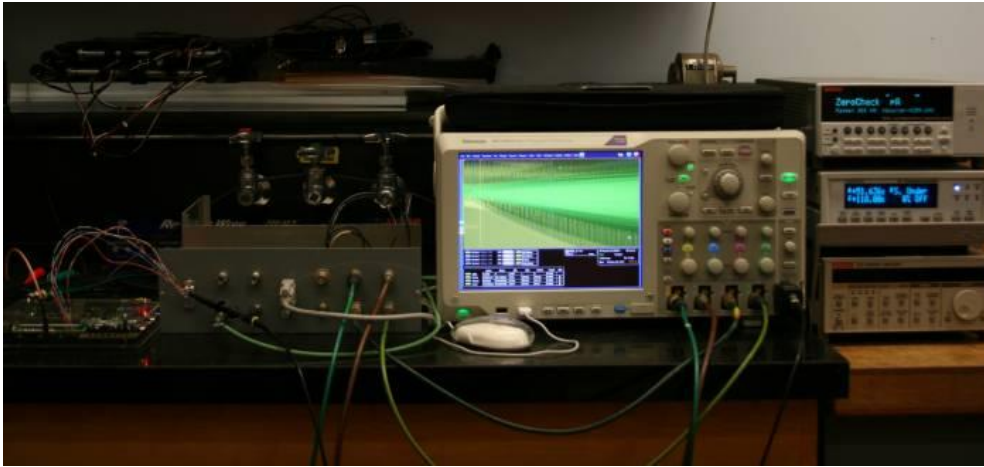


**topmetal
wafer**



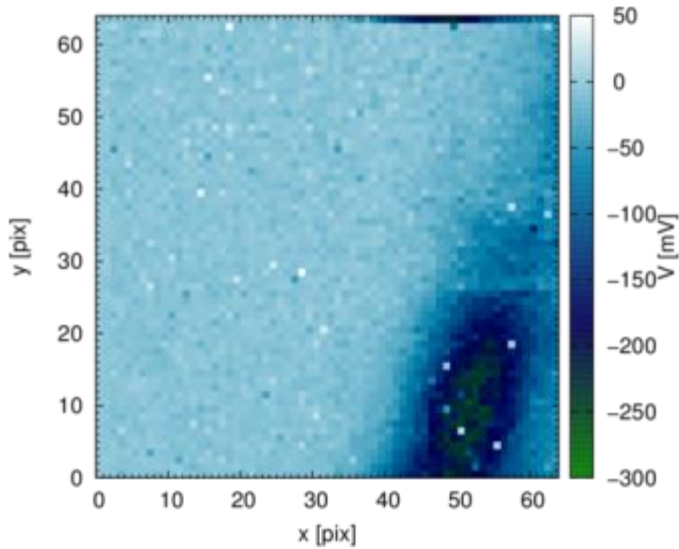
**Topmetal
microscope
picture (pitch
80um)**

TopMetal test setup

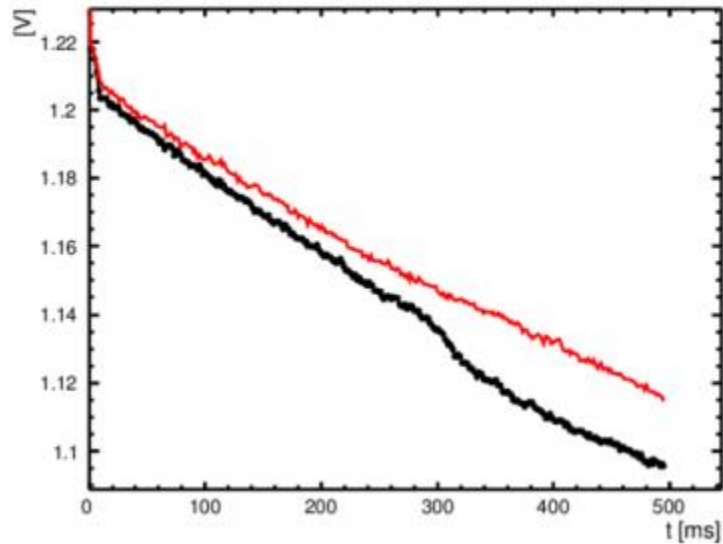
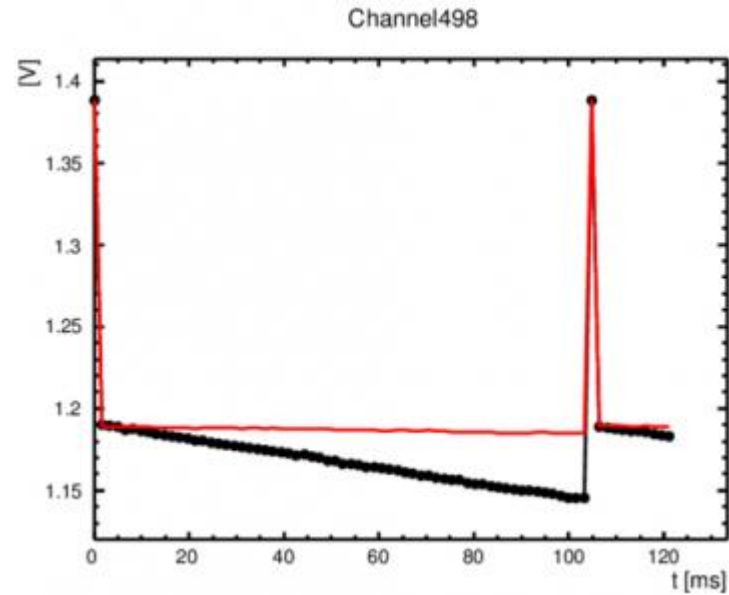




TopMetal test

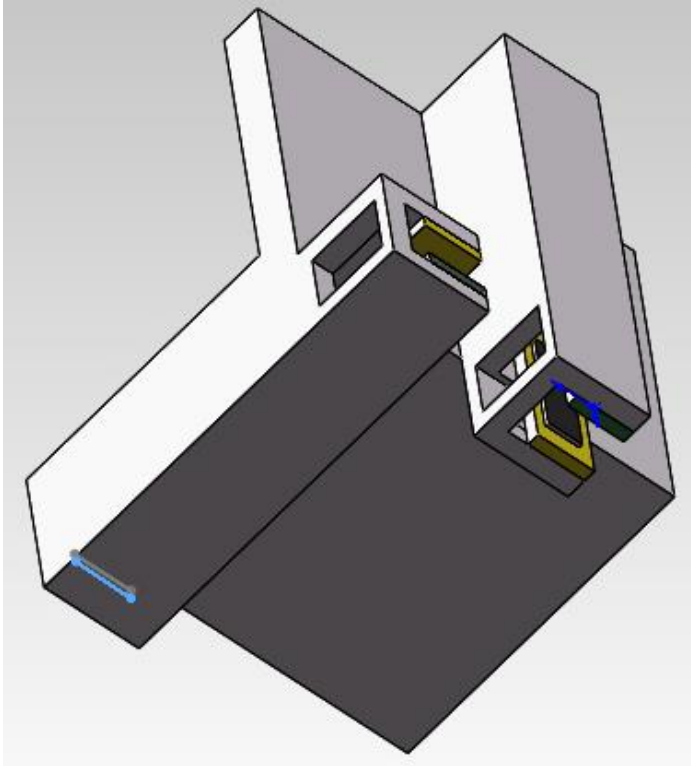


Channel2504



peak: reset
red line (no source)
black source (with source)
Source: Am241, 5.4MeV alpha
bottom left: charge burst

Beam monitor



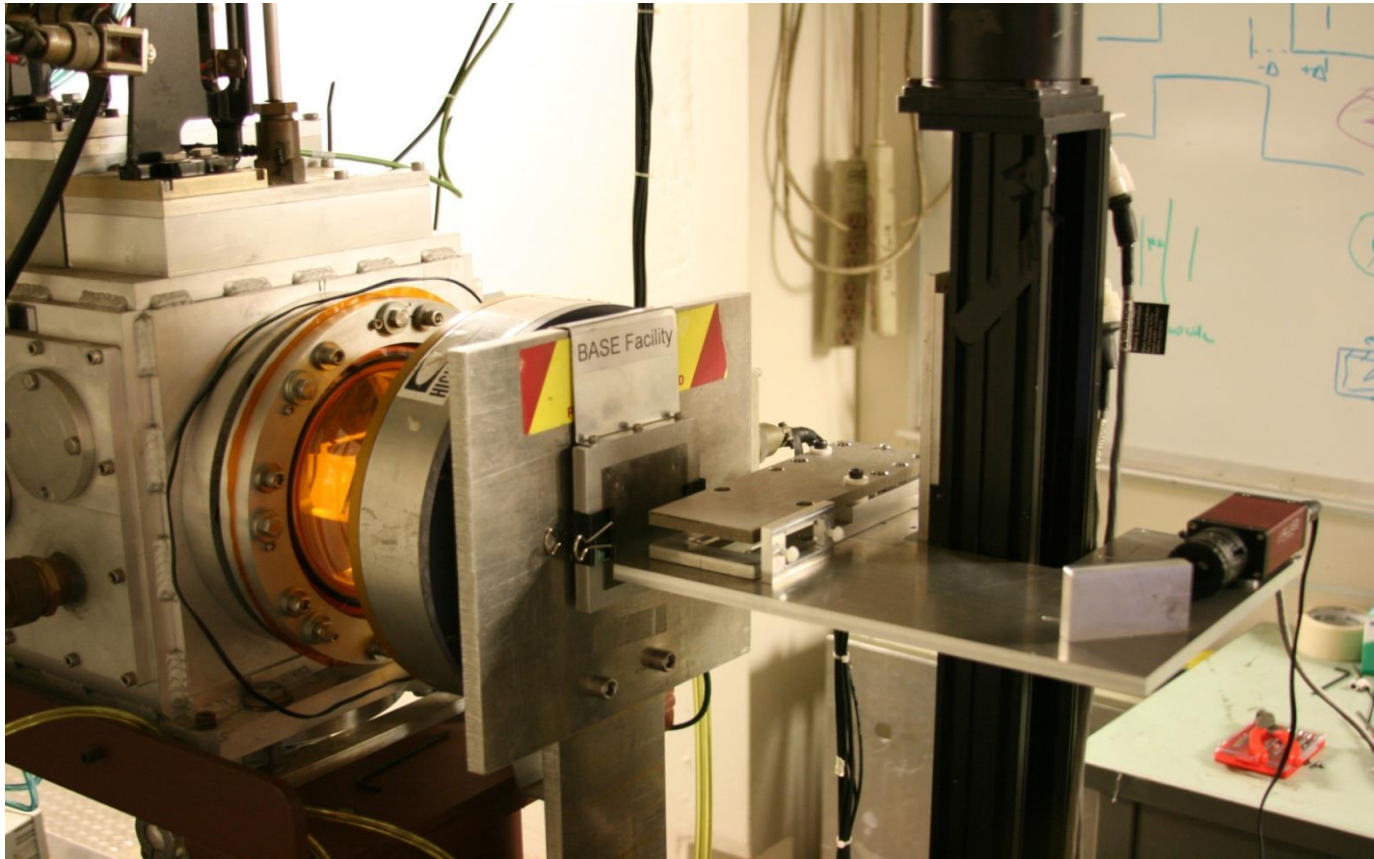
integration time: 1ms
beam current: 1pA
resolution: $<1\mu\text{m}$

for hadron therapy

- 1, high precision
- 2, no radiation damage
- 3, low radiation length
- 4, linear extension



Beam test at the 88 cyclotron, LBNL



Beam monitor in air

13.5MeV proton from Cyclotron; 20nA over 3x3 inch area

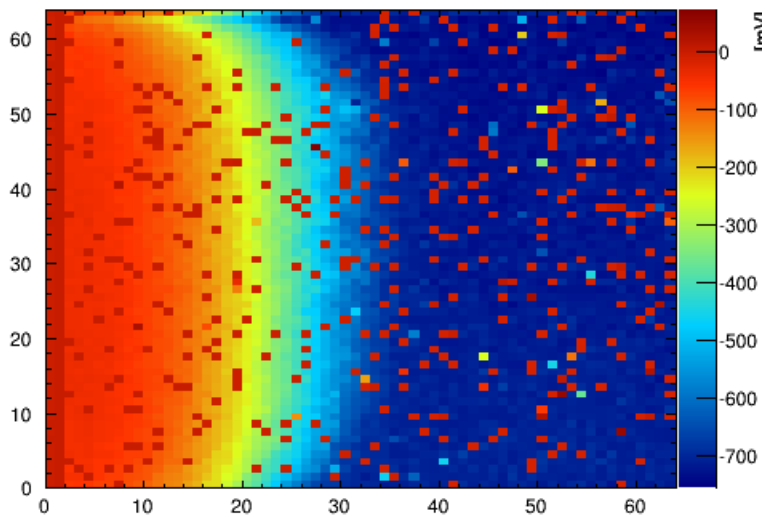
Collimated with a pinhole, as small as 0.1mm diameter



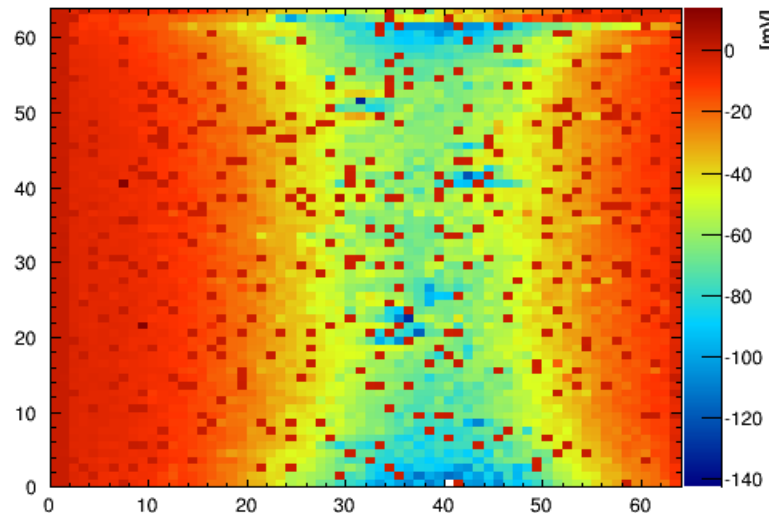
Beam test at the 88 cyclotron, LBNL



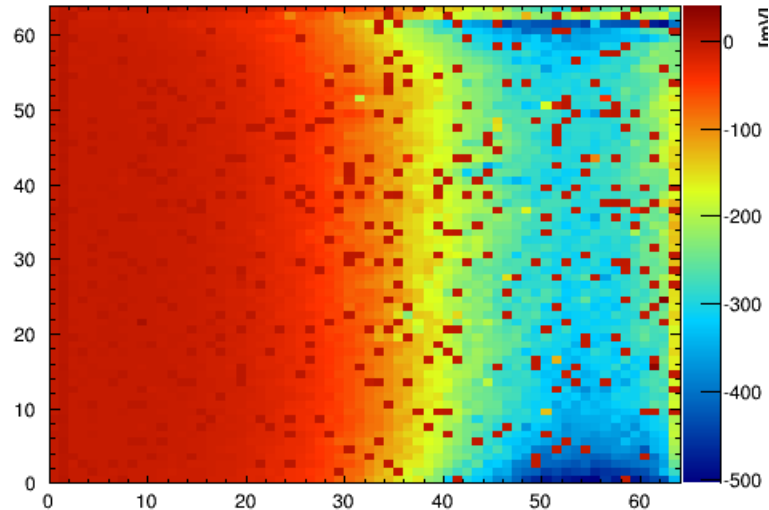
2mm hole



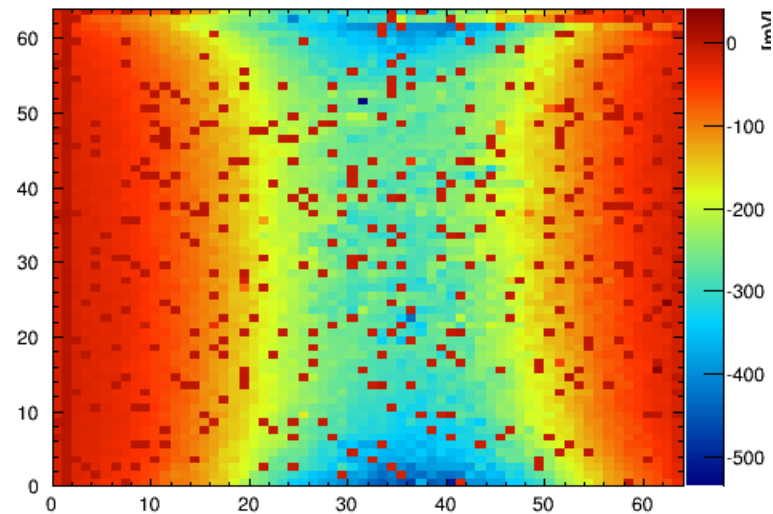
0.5mm hole



1mm hole



1mm hole

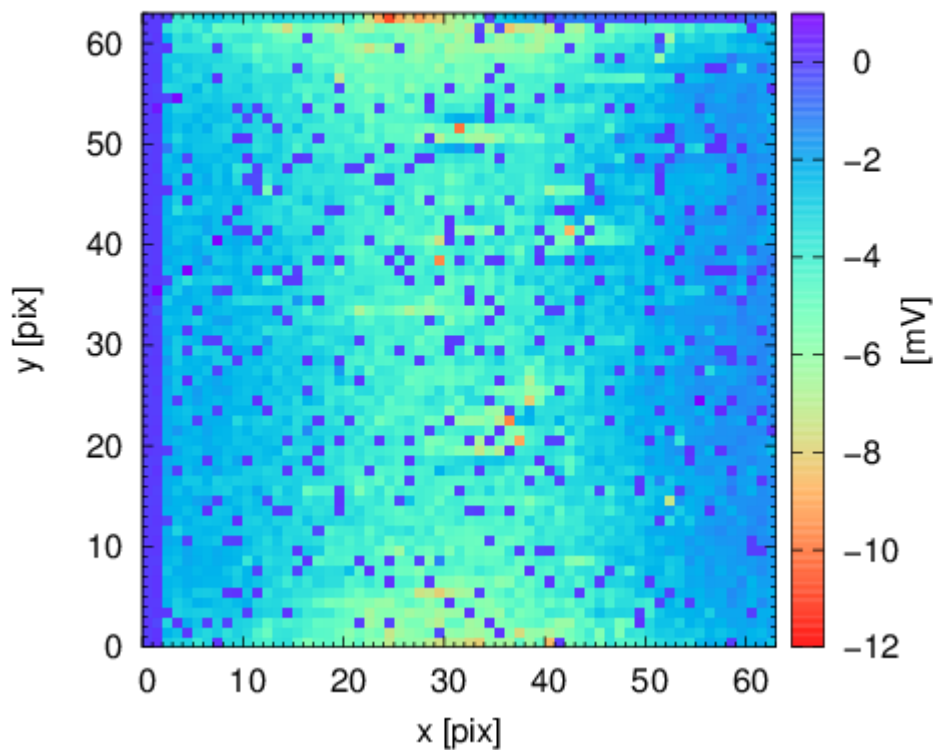




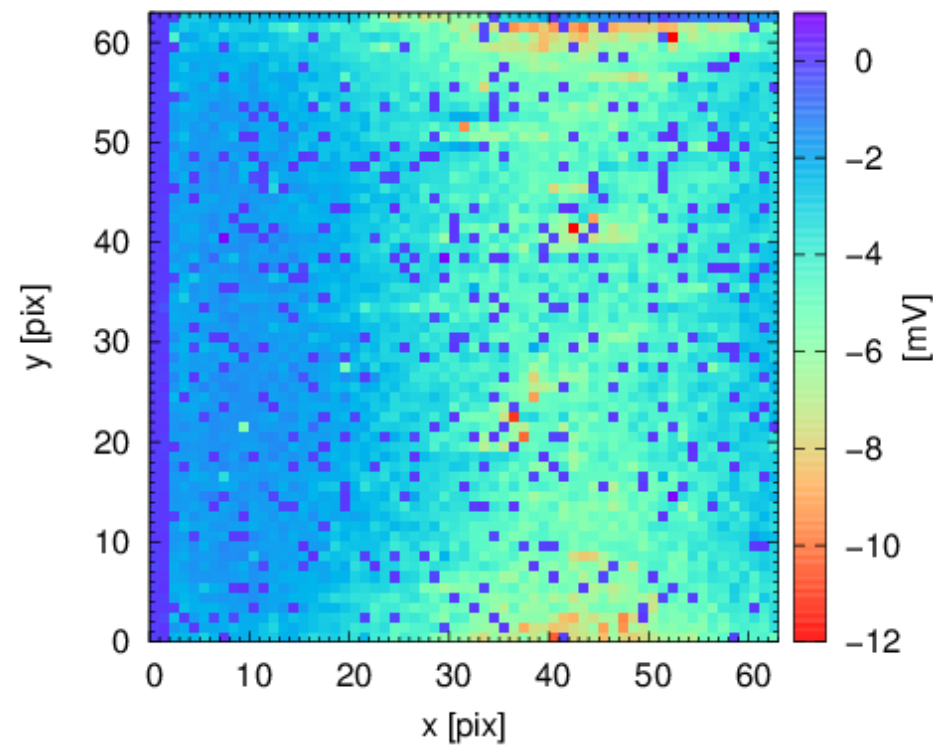
Beam test at the 88 cyclotron, LBNL



13.5MeV proton, 0.1mm hole #2



13.5MeV proton, 0.1mm hole #3



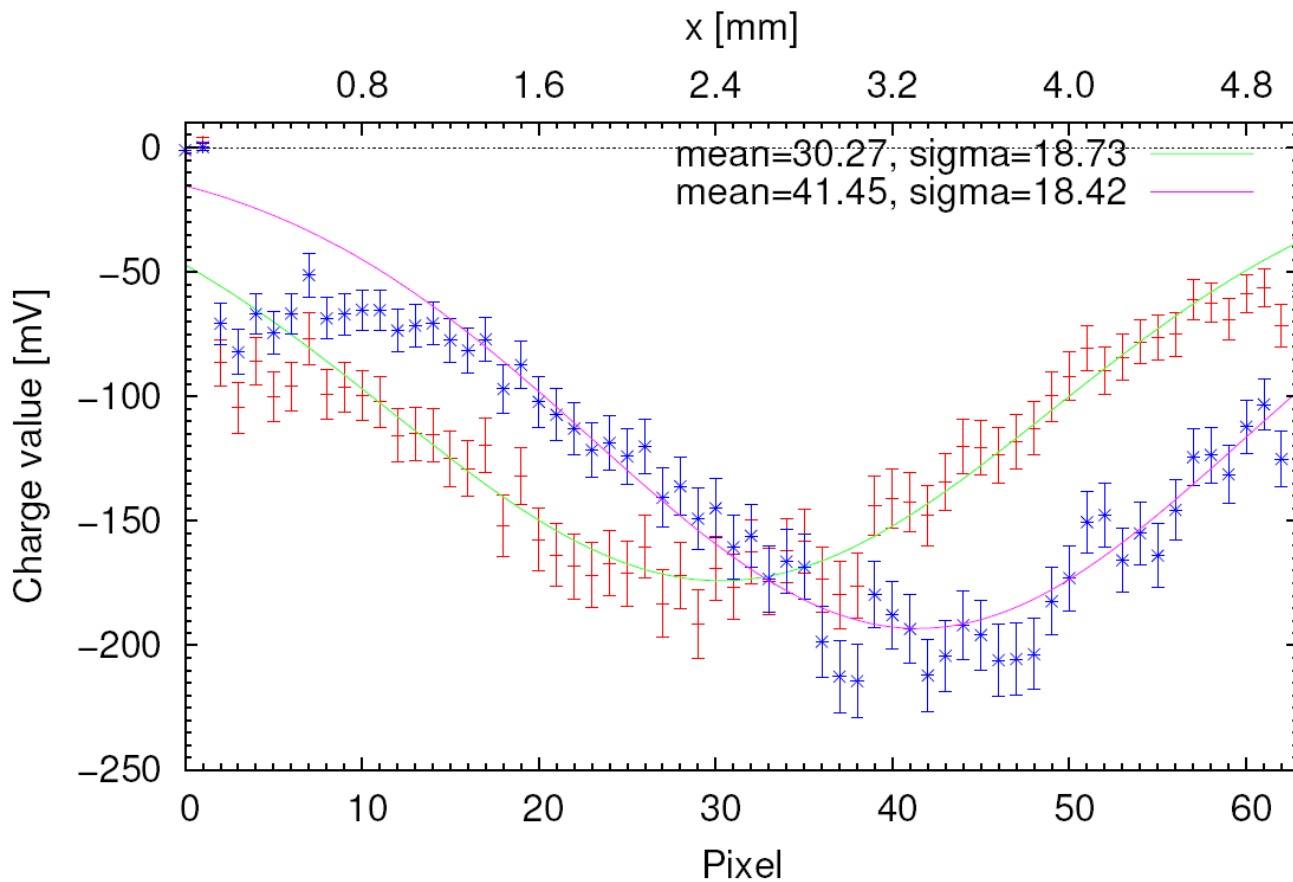
Beam current 20fA



Beam test at the 88 cyclotron, LBNL



13.5MeV proton, 0.1mm hole, projection from bin 10 to 53

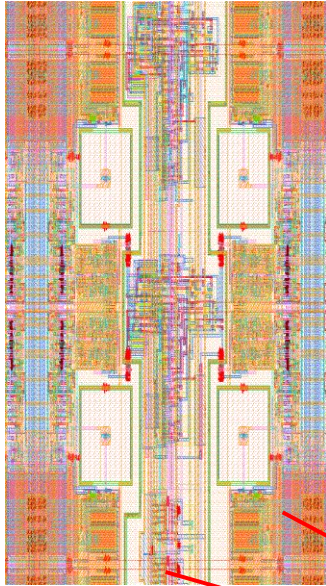




ALICE ITS upgrade

- ALICE ITS sensor : temperature sensor
- ALICE ITS test and assembly : infrastructure & pattern recognition
- ALICE ITS readout : SRU & UDP+TCP
- summary

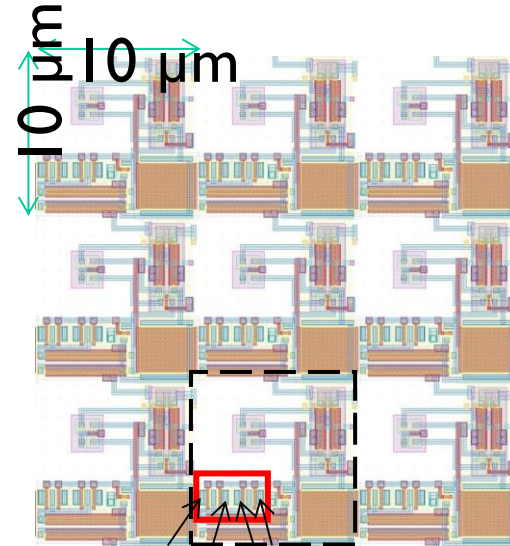
28 μm



Analog frontend

Priority encoder

Layout view



Out1 Out2 Out3 Out4

readout and OrthoPix

- ▶ sensor design (2 student)



Temperature sensor



Temperature sensor on the chip gives real-time temperature to

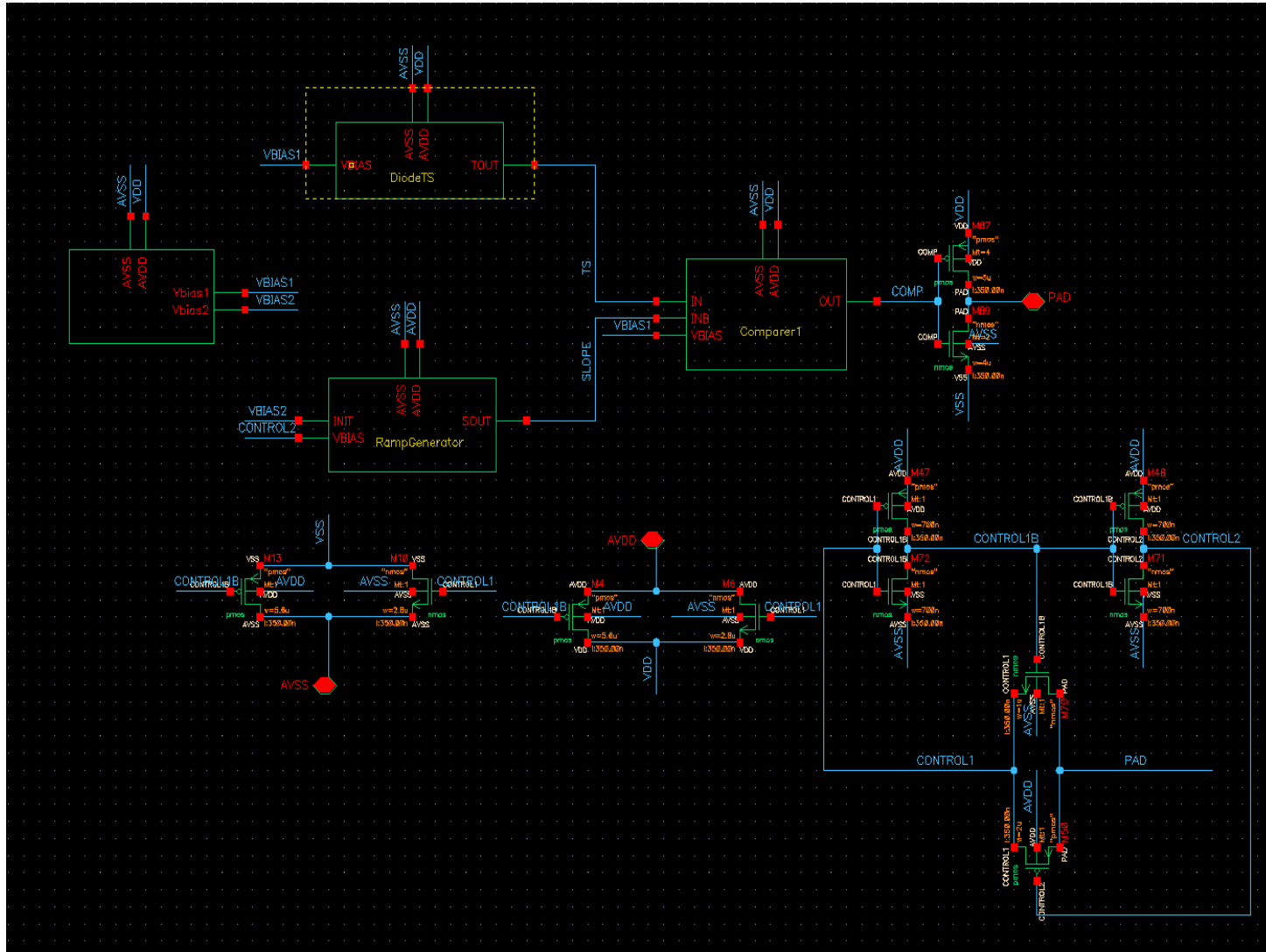
- 1, show the relation between cooling and power consumption
- 2, calibrate the sensor performance on different temperature

single pad temperature sensor

- 1、 1 pad digital signal
- 2、 power consumption
 - ~5uA(working)
 - ~1pA(idle)
- 3、 FPGA directly connect to the pad



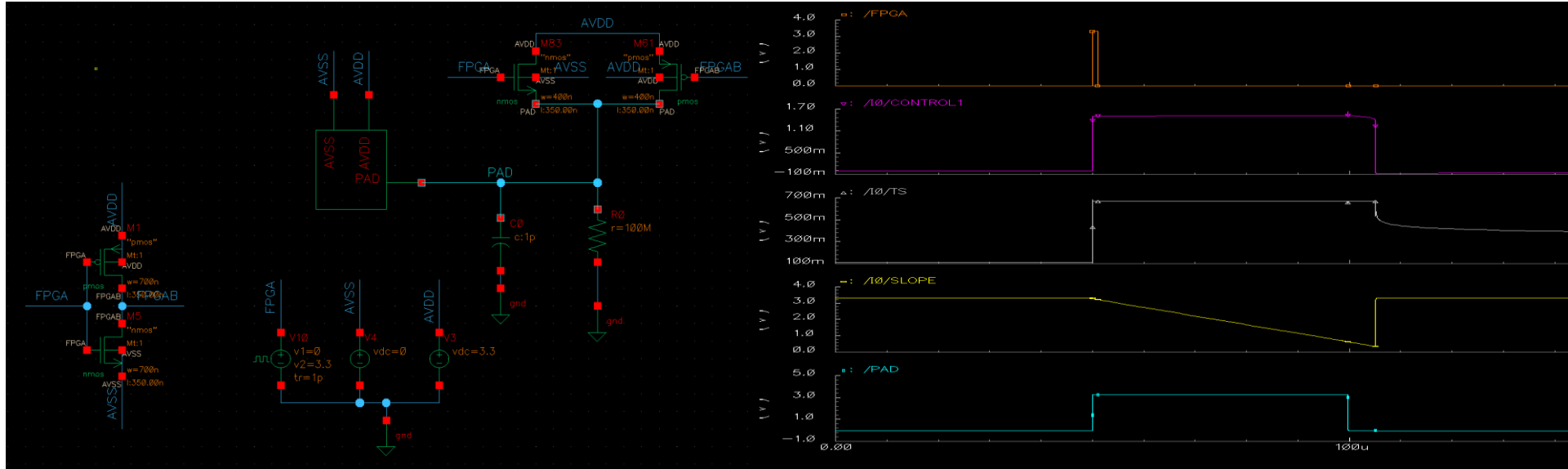
Temperature sensor structure



diode+slope+comparator



Temperature sensor testbench



- 1、 FPGA send rising edge to pad. The circuit starts while FPGA drive the pad to high impedance mode.
as the circuit starts, the slope voltage will pass the diode voltage on the input of the comparator, the comparator will drive the pad to low.
- 2、 FPGA count the time between the rising edge and falling edge to the diode voltage.



ALICE ITS test and assembly



- ladder assembly
- ladder test
- module assembly
- module test



Test and assembly infrastructure



- 150 square meters clean room
- 50 square meters machining shop
- simple modeling carbon fiber



Pattern recognition



- 1, using camera or microscope to take picture.
- 2, analysing the picture to get the position and orientation of the sensor
- 3, control the movement of probe station or precision rail to act on the sensor

probe test the sensor
assembly the sensor to ladder

saving labor

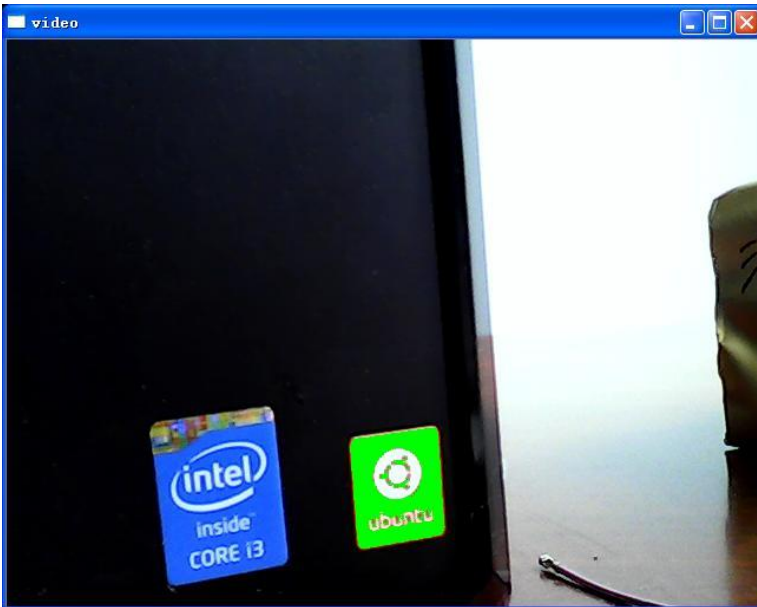
higher precision

more time to train the code



Pattern recognition

- openCV + root software environment in windows
- With PC camera now; installing camera on rail system is the next step





ALICE ITS readout

For digital data transmission only

- 1,SRU (from digitized point to RORC)
- 2,UDP+TCP solution (from digitized point to either net card;No DDL included)



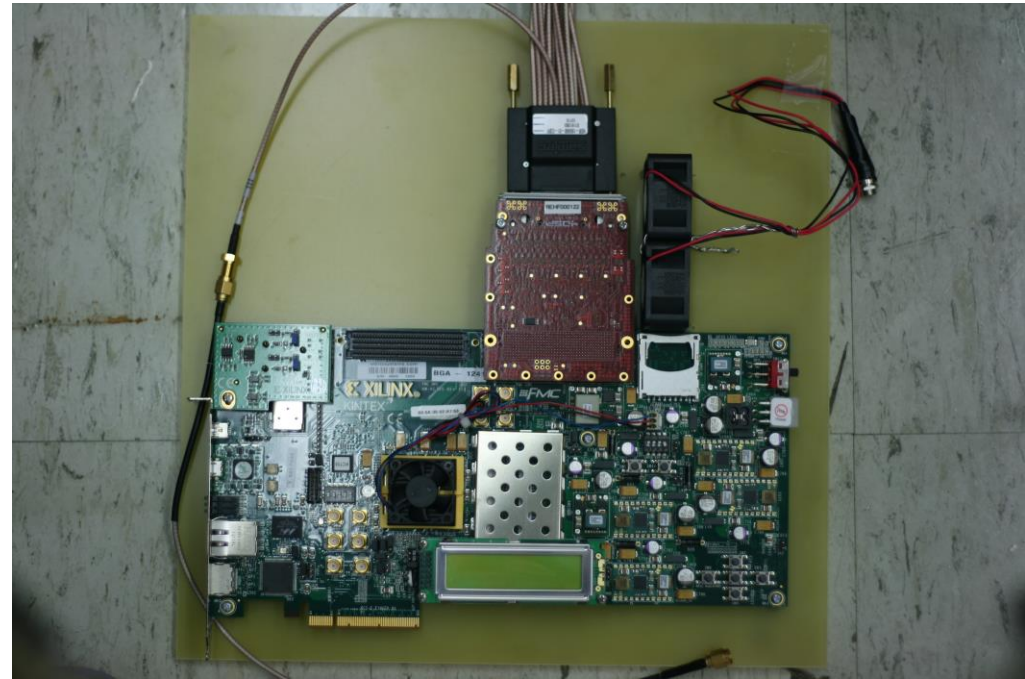
UDP+TCP solution



- the same function like DDL
- higher speed 10Gb/channel
- industry standard; update with industry
- compatible to router
- FPGA xilinx K7; board KC705
- cheaper and simpler in construction

UDP+TCP solution

- works on LBL beam monitor test
- UDP part has some problem in frimware yet





summary

- TopMetal sensor can be used in beam monitor
- temperature sensor
- pattern recognition
- UDP+TCP